



Item	Title	Material	Dispose	Remark
1	Terminal	Copper Alloy	Mating Area:See P/N Solder Tails:Cu	t=0.20
2	InsertMolding	LCP	Mating Area:See P/N Solder Tails:Sn	Black
3	Shell	Copper Alloy	Ni:50u" Min.	t=0.50

X. ± 0.35	HDMI-A/F CONN. SMT TYPE 1.90	Micro-Ray
.X ± 0.30		
.XX ± 0.25		
.XXX±	DR: Jason Su	PART NO: MR-A111910-F-XX-X
X* ± 2*	UNITS: mm	SCALE: 1:1
.X* ± 1.5*		
		CUSTOMER DRAWING
		SHEET:10F1
		REV: C

REV	ECN NO	DESCRIPTION	DATE
C	TE2015-0157	新增规格端子尾部雾锡80u"Min	2015.05.18
B	TE2011-0276	新开外壳模具, 改善外壳结构不良	2011.05.30
A	TE2010-213	初版发行	2010.04.13